

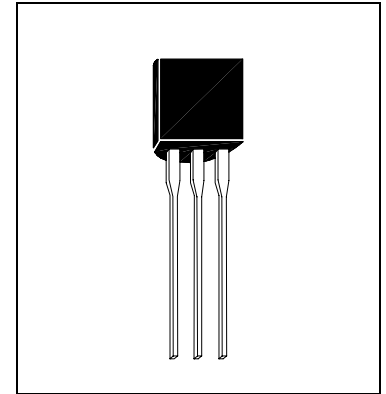


# H2N5087

PNP EPITAXIAL PLANAR TRANSISTOR

## Description

This device was designed for low noise, high gain, general purpose amplifier applications for 1uA to 25mA collector current.



## Absolute Maximum Ratings

- Maximum Temperatures  
 Storage Temperature ..... -55 ~ +150 °C  
 Junction Temperature ..... +150 °C Maximum
- Maximum Power Dissipation  
 Total Power Dissipation (Ta=25°C) ..... 625 mW
- Maximum Voltages and Currents (Ta=25°C)  
 VCBO Collector to Base Voltage ..... -50 V  
 VCEO Collector to Emitter Voltage ..... -50 V  
 VEBO Emitter to Base Voltage ..... -3 V  
 IC Collector Current ..... -50mA

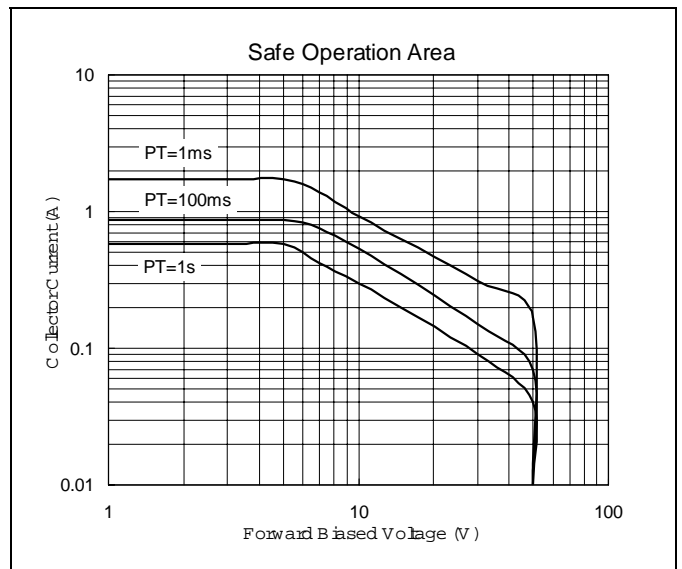
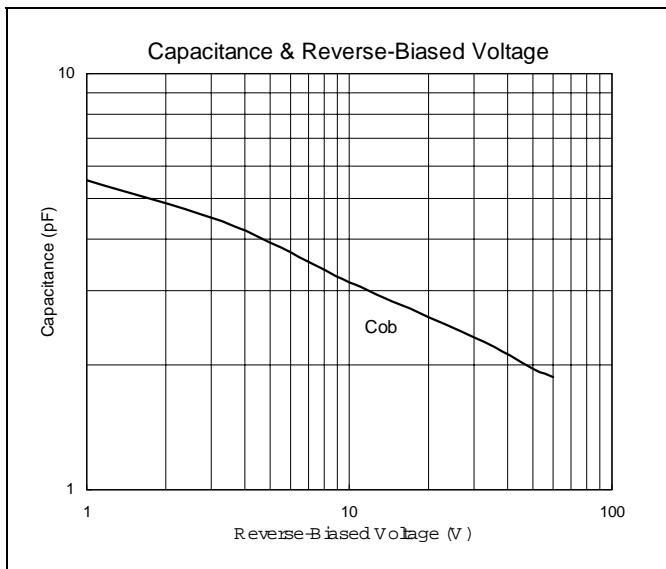
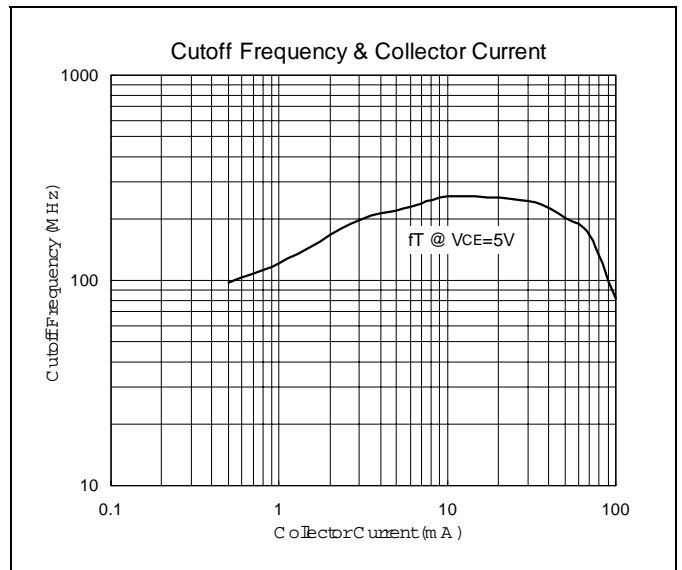
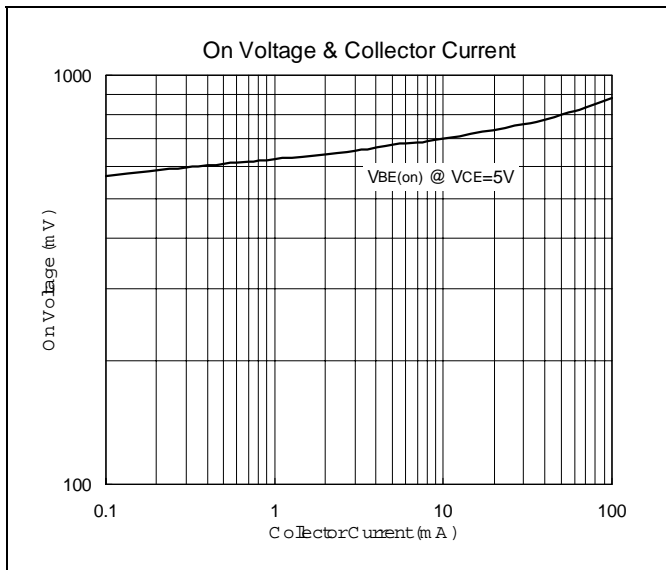
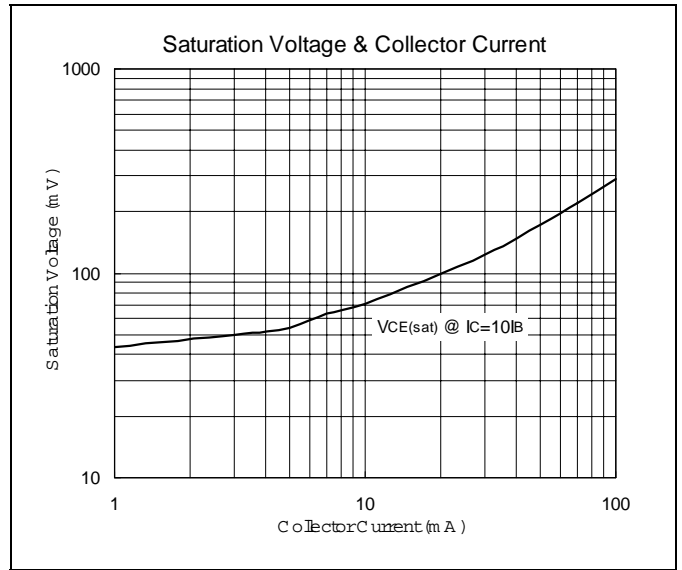
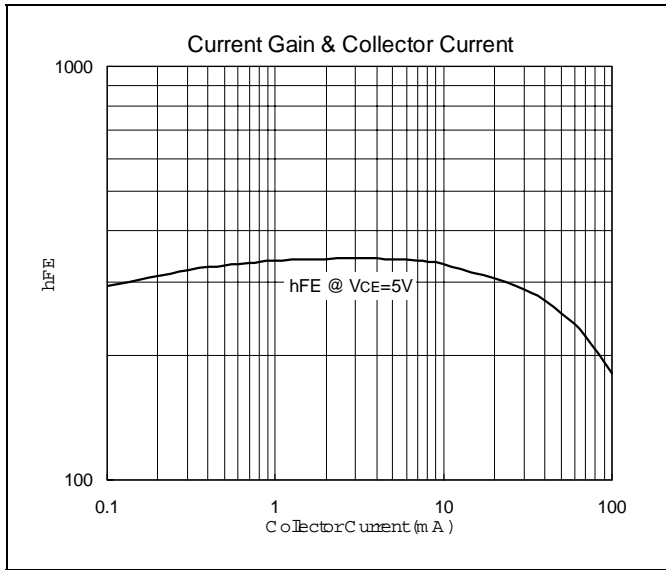
## Characteristics (Ta=25°C)

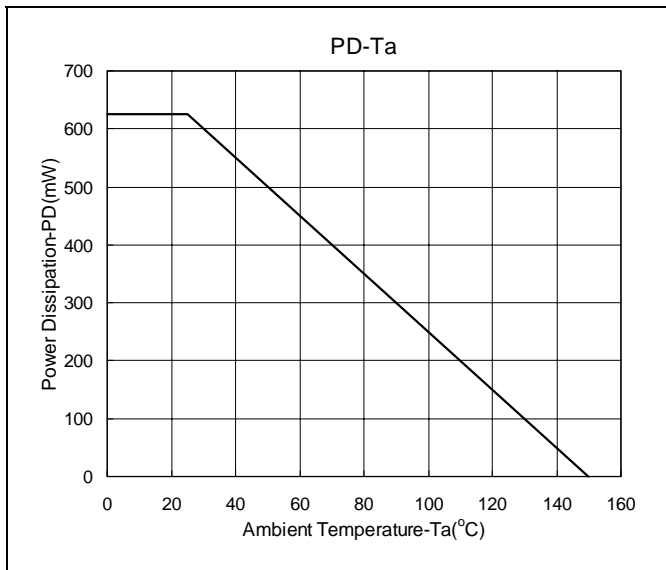
Symbol	Min.	Typ.	Max.	Unit	Test Conditions
BVCBO	-50	-	-	V	IC=-100uA
BVCEO	-50	-	-	V	IC=-1mA
BVEBO	-3	-	-	V	IE=-10uA
ICBO	-	-	-50	nA	VCB=-35V
IEBO	-	-	-50	nA	VEB=-3V
*VCE(sat)	-	-	-0.3	V	IC=-10mA, IB=-1mA
VBE(on)	-	-	-0.85	V	IC=-10mA, IB=-5V
*hFE1	250	-	800		VCE=-5V, IC=-0.1mA
*hFE2	250	-	-		VCE=-5V, IC=-1mA
*hFE3	250	-	-		VCE=-5V, IC=-10mA
fT	40	-	-	MHz	IC=-0.5mA, VCE=-5V, f=100MHz
Cob	-	-	4.0	pF	VCB=-5V, f=1MHz

\*Pulse Test : Pulse Width ≤380us, Duty Cycle≤2%



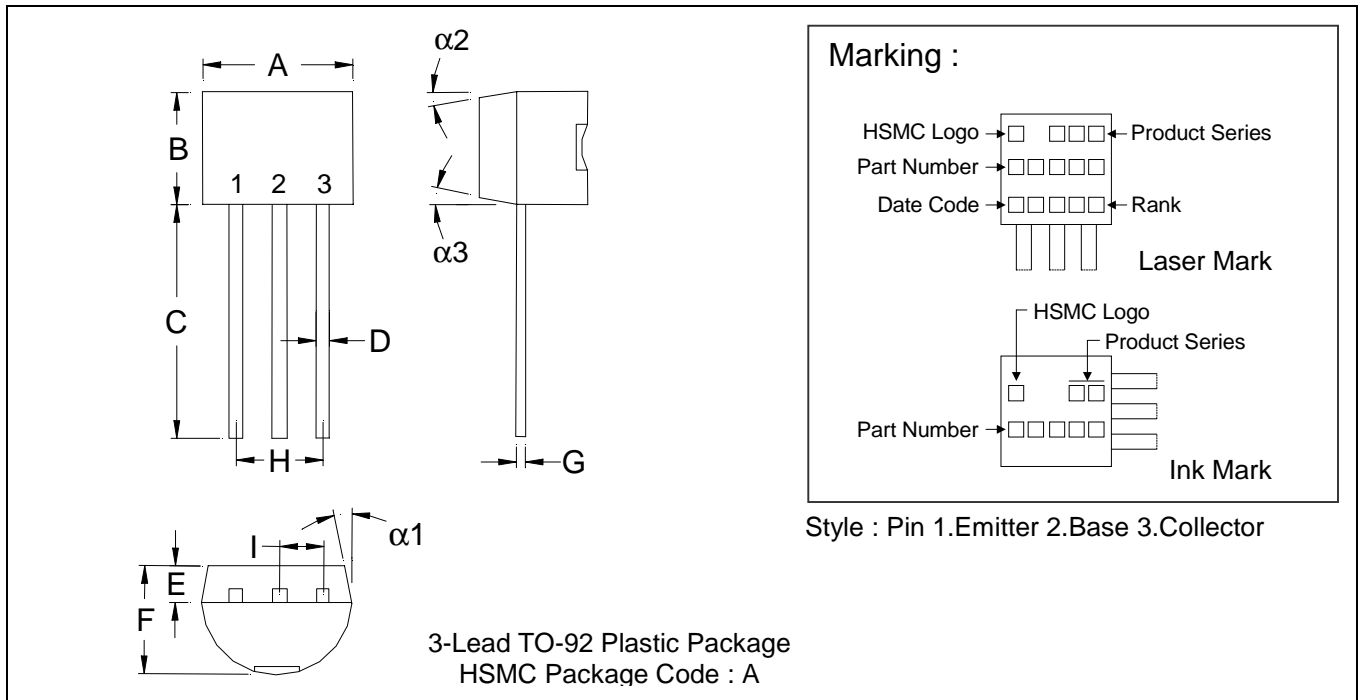
### Characteristics Curve







### TO-92 Dimension



\*:Typical

DIM	Inches		Millimeters		DIM	Inches		Millimeters	
	Min.	Max.	Min.	Max.		Min.	Max.	Min.	Max.
A	0.1704	0.1902	4.33	4.83	G	0.0142	0.0220	0.36	0.56
B	0.1704	0.1902	4.33	4.83	H	-	*0.1000	-	*2.54
C	0.5000	-	12.70	-	I	-	*0.0500	-	*1.27
D	0.0142	0.0220	0.36	0.56	α1	-	*5°	-	*5°
E	-	*0.0500	-	*1.27	α2	-	*2°	-	*2°
F	0.1323	0.1480	3.36	3.76	α3	-	*2°	-	*2°

Notes : 1.Dimension and tolerance based on our Spec. dated Apr. 25,1996.  
 2.Controlling dimension : millimeters.  
 3.Maximum lead thickness includes lead finish thickness, and minimum lead thickness is the minimum thickness of base material.  
 4.If there is any question with packing specification or packing method, please contact your local HSMC sales office.

**Material :**

- Lead : 42 Alloy ; solder plating
- Mold Compound : Epoxy resin family, flammability solid burning class:UL94V-0

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